

MOSFET

OptiMOS[™] 5 Power-Transistor, 80 V

Features

- Ideal for high frequency switching and sync. rec.
 Excellent gate charge x R_{DS(on)} product (FOM)
 Very low on-resistance R_{DS(on)}
 N-channel, normal level

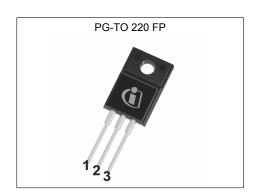
- 100% avalanche tested
- Pb-free plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

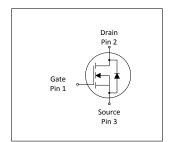
Product validation

Qualified according to JEDEC Standard

Kev Performance Parameters Table 1

Take to Troy T of Total Marie Total Control							
Parameter	Value	Unit					
V _{DS}	80	V					
R _{DS(on),max}	4.0	mΩ					
I_{D}	75	A					
Qoss	83	nC					
Q _G (0V10V)	70	nC					











Type / Ordering Code	Package	Marking	Related Links
IPA040N08NM5S	PG-TO 220 FullPAK	040N085S	-

OptiMOSTM 5 Power-Transistor, 80 V IPA040N08NM5S



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OptiMOS[™] 5 Power-Transistor, 80 V IPA040N08NM5S



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Davamatan	Symbol I _D	Values				Note / Tool Constition
Parameter		Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current			75 53	A	V _{GS} =10 V, T _C =25 °C V _{GS} =10 V, T _C =100 °C	
Pulsed drain current ¹⁾	I _{D,pulse}	-	-	300	Α	T _C =25 °C
Avalanche energy, single pulse ²⁾	E AS	-	-	186	mJ	$I_{\rm D}$ =75 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	39	W	T _C =25 °C
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	IEC climatic category; DIN IEC 68-1: 55/175/56

2 Thermal characteristics

Table 3 Thermal characteristics

Doromotor	Values				l lmit	Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case	R _{thJC}	-	-	3.8	°C/W	-	

3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

Parameter	0		Values			
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	80	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	V _{GS(th)}	2.2	3.0	3.8	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 109 \mu {\rm A}$
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μA	V _{DS} =80 V, V _{GS} =0 V, T _j =25 °C V _{DS} =80 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	1	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	3.4 4.2	4.0	mΩ	V _{GS} =10 V, I _D =38 A V _{GS} =6 V, I _D =19 A
Gate resistance ³⁾	R _G	-	1.5	-	Ω	-
Transconductance	g fs	-	93	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 38 \text{ A}$

See Diagram 3 for more detailed information
 See Diagram 13 for more detailed information
 Defined by design. Not subject to production test.

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Table 5 Dynamic characteristics

Davamatar	Cumbal	Values			11	Nata / Tast Candition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	Ciss	-	4900	6400	pF	V _{GS} =0 V, V _{DS} =40 V, <i>f</i> =1 MHz
Output capacitance	Coss	-	790	-	pF	V _{GS} =0 V, V _{DS} =40 V, f=1 MHz
Reverse transfer capacitance	C _{rss}	-	36	-	pF	V _{GS} =0 V, V _{DS} =40 V, f=1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	18	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =38 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	12	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =38 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{ m d(off)}$	-	37	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =38 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	12	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =38 A, $R_{\rm G,ext}$ =1.6 Ω

Table 6 Gate charge characteristics²⁾

Parameter	0	Values				
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	22	-	nC	$V_{\rm DD}$ =40 V, $I_{\rm D}$ =38 A, $V_{\rm GS}$ =0 to 10 V
Gate charge at threshold	$Q_{g(th)}$	-	15	-	nC	$V_{\rm DD}$ =40 V, $I_{\rm D}$ =38 A, $V_{\rm GS}$ =0 to 10 V
Gate to drain charge	Q _{gd}	-	15	-	nC	$V_{\rm DD}$ =40 V, $I_{\rm D}$ =38 A, $V_{\rm GS}$ =0 to 10 V
Switching charge	Q _{sw}	-	22	-	nC	$V_{\rm DD}$ =40 V, $I_{\rm D}$ =38 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total ¹⁾	Qg	-	70	93	nC	$V_{\rm DD}$ =40 V, $I_{\rm D}$ =38 A, $V_{\rm GS}$ =0 to 10 V
Gate plateau voltage	V _{plateau}	-	4.5	-	V	$V_{\rm DD}$ =40 V, $I_{\rm D}$ =38 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total, sync. FET	Q _{g(sync)}	-	60	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V
Output charge	Q _{oss}	-	83	-	nC	V _{DD} =40 V, V _{GS} =0 V

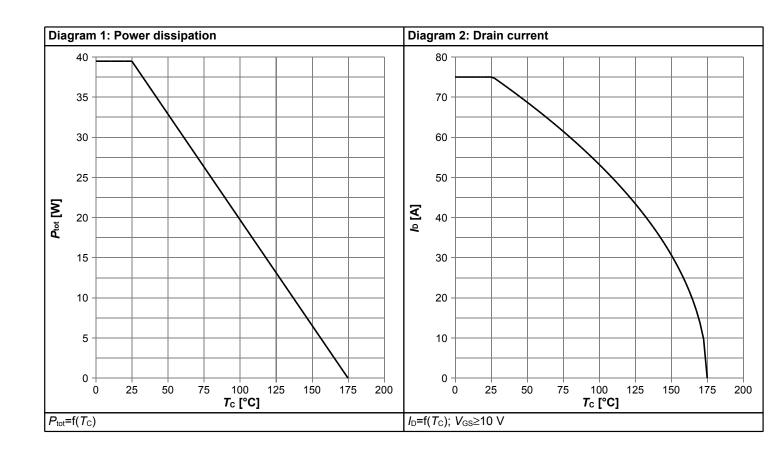
Table 7 Reverse diode

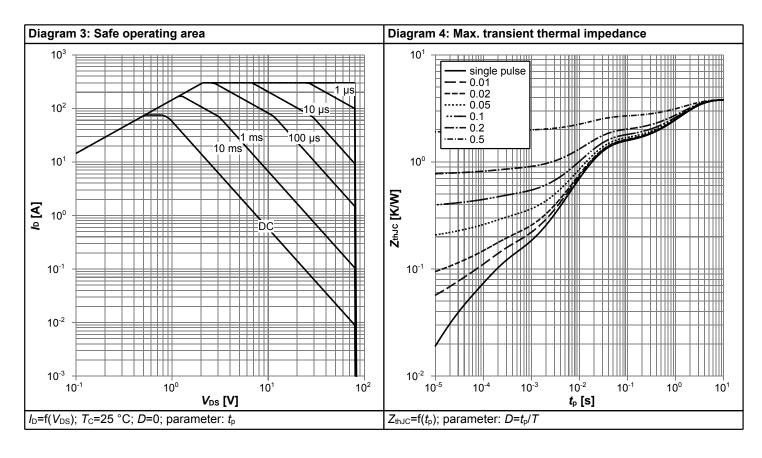
Doromotor	Symbol		Values			Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	33	Α	<i>T</i> _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	300	Α	<i>T</i> _C =25 °C
Diode forward voltage	V _{SD}	-	0.87	1.2	V	V _{GS} =0 V, I _F =38 A, T _j =25 °C
Reverse recovery time ¹⁾	t _{rr}	-	73	-	ns	V _R =40 V, I _F =38 A, di _F /dt=100 A/μs
Reverse recovery charge ¹⁾	Qrr	-	166	-	nC	V _R =40 V, I _F =38 A, d <i>i</i> _F /d <i>t</i> =100 A/μs

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

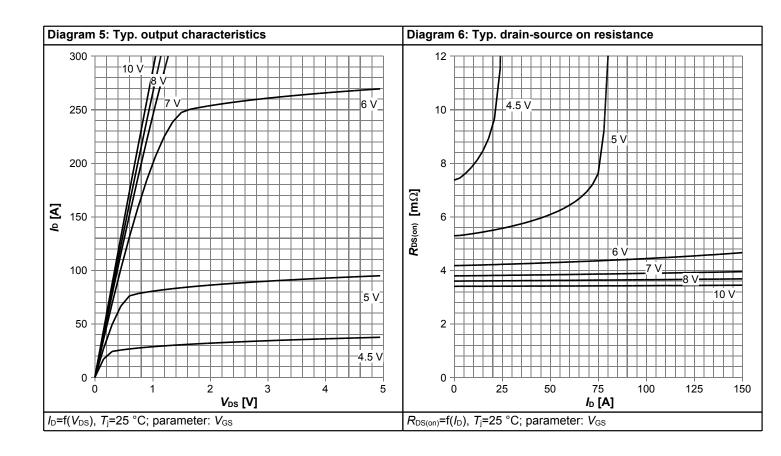


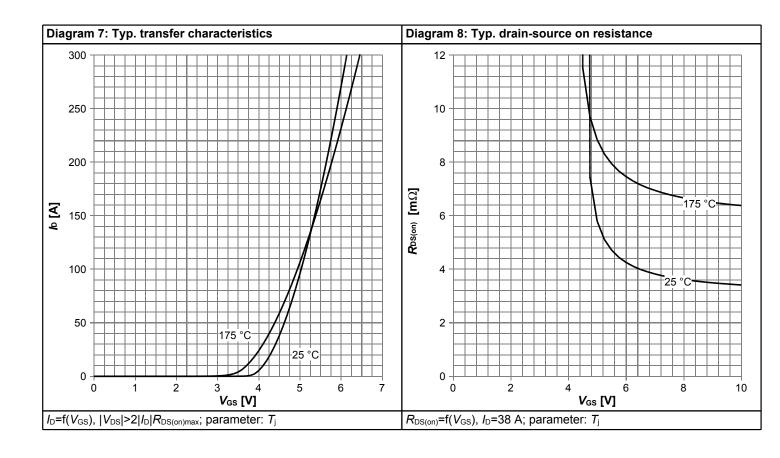
4 Electrical characteristics diagrams



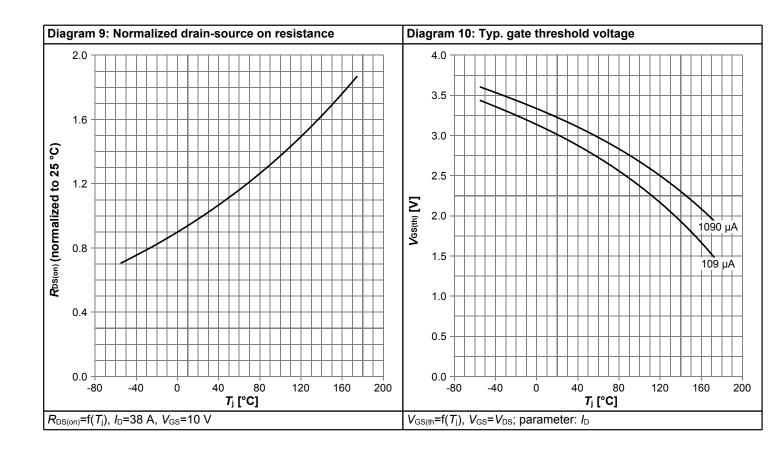


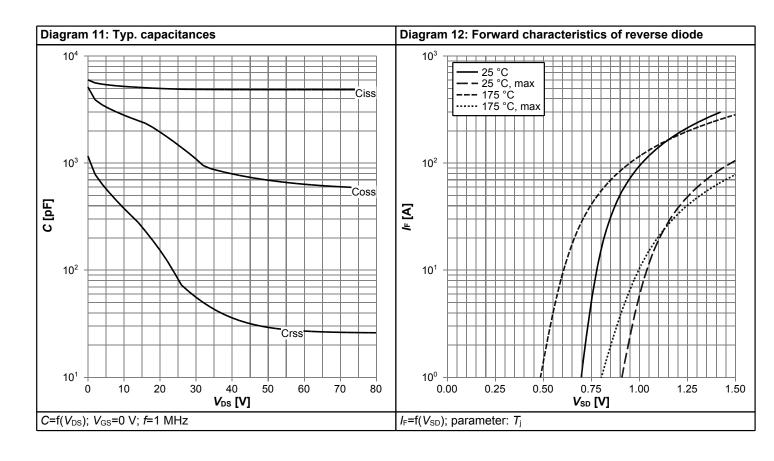




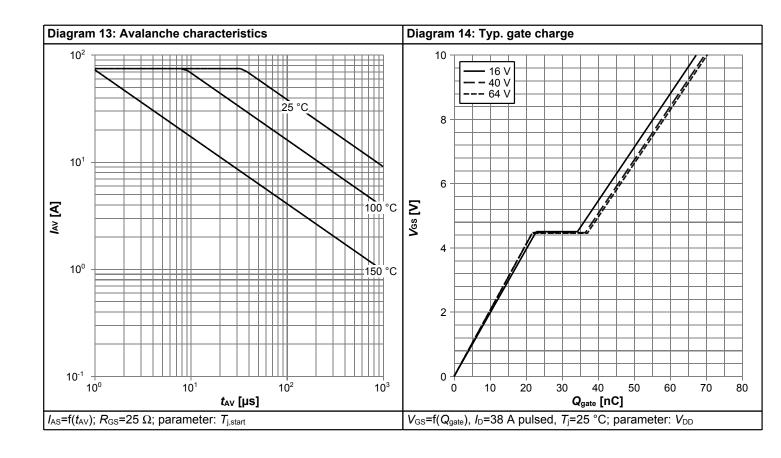


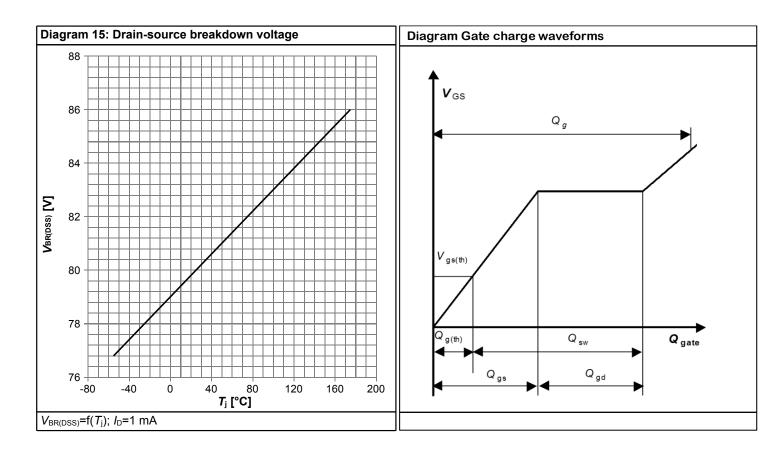














5 Package Outlines

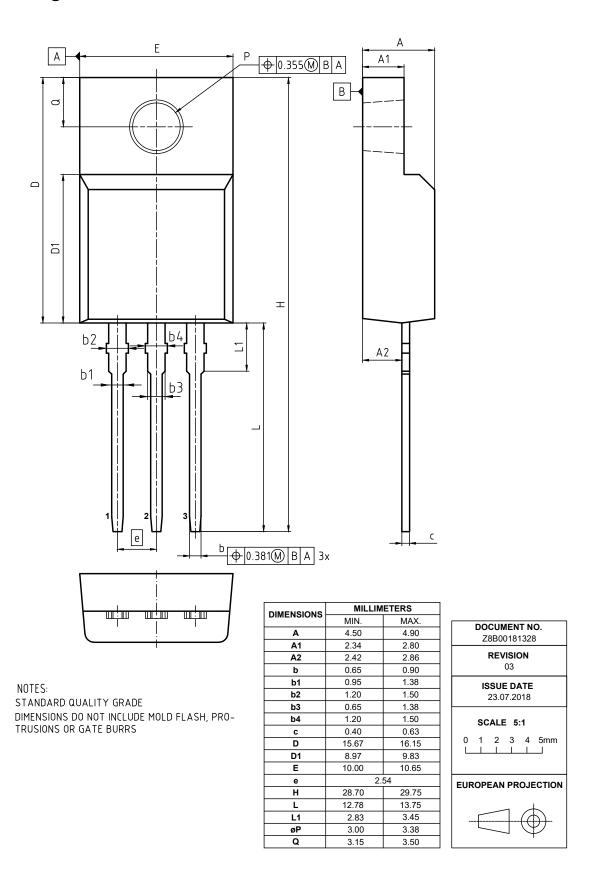


Figure 1 Outline PG-TO 220 FullPAK, dimensions in mm/inches

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IPA040N08NM5S



Revision History

IPA040N08NM5S

Revision: 2019-09-02, Rev. 2.1

Previous Revision

Trevious Newtonian							
Revision	Date	Subjects (major changes since last revision)					
2.0	2019-07-23	Release of final version					
2.1	2019-09-02	Update package outline					

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